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(12) **United States Design Patent**  
**He**

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(54) **OVER EAR HEADPHONES**

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(\*\*) Term: **15 Years**

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(52) **U.S. Cl.**  
USPC ..... **D14/206; D14/205; D14/226**

(58) **Field of Classification Search**  
USPC ..... D14/206, 226, 205, 225, 188, 192;  
D29/112; 2/209; 381/380–381, 374;  
455/90.3, 575.1, 569.1  
CPC ..... H04R 25/00; H04R 25/02; H04R 1/1066;  
H04R 1/1016; H04R 5/033; H04R  
5/0335; H04R 1/10; H04R 1/1041; H04R  
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H04R 19/04; H04R 1/1091  
See application file for complete search history.

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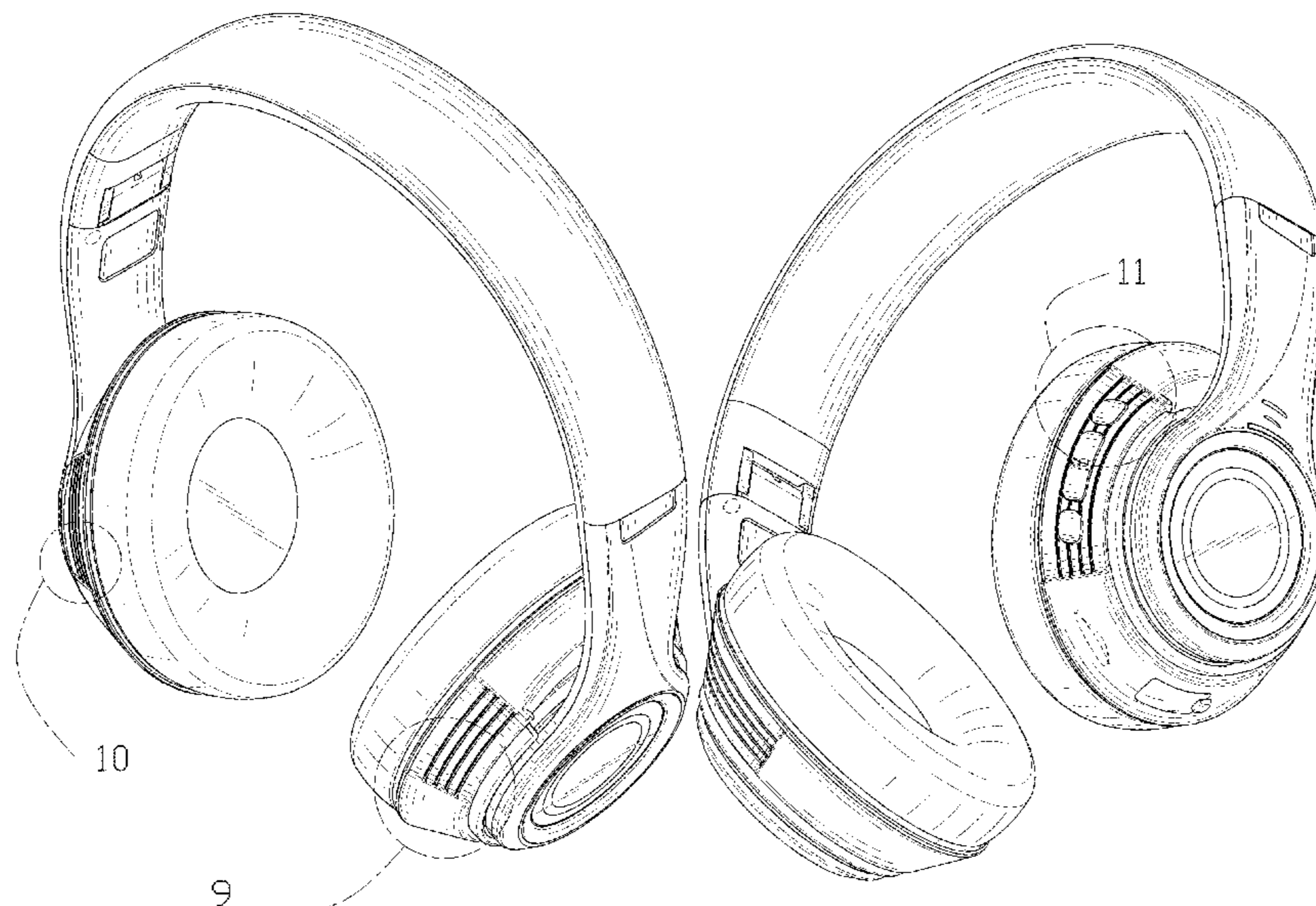
(57) **CLAIM**

The ornamental design for an over ear headphones, as shown and described.

**DESCRIPTION**

FIG. 1 is a front, right, and top perspective view of an over ear headphones, showing my design.  
 FIG. 2 is a rear, left, and bottom perspective view thereof.  
 FIG. 3 is a front elevation view thereof.  
 FIG. 4 is a rear elevation view thereof.  
 FIG. 5 is a left side elevation view thereof.  
 FIG. 6 is a right side elevation view thereof.  
 FIG. 7 is a top plan view thereof.  
 FIG. 8 is a bottom plan view thereof.  
 FIG. 9 is a partial enlarged view of an area labeled 9 in FIG. 1 comprising a right headset part.  
 FIG. 10 is a partial enlarged view of an area labeled 10 in FIG. 1 comprising a left headset part; and,  
 FIG. 11 is a partial enlarged view of an area labeled 11 in FIG. 2 comprising a left headset part.  
 The broken lines shown in the drawings are included for the purpose of illustrating portions of the over ear headphones that form no part of the claimed design.  
 The dot-dash-dot broken lines encircling portions of the over ear headphones in FIGS. 1 and 2 and illustrated in enlarged views of FIGS. 9 through 11 form no part of the claimed design.

**1 Claim, 11 Drawing Sheets**



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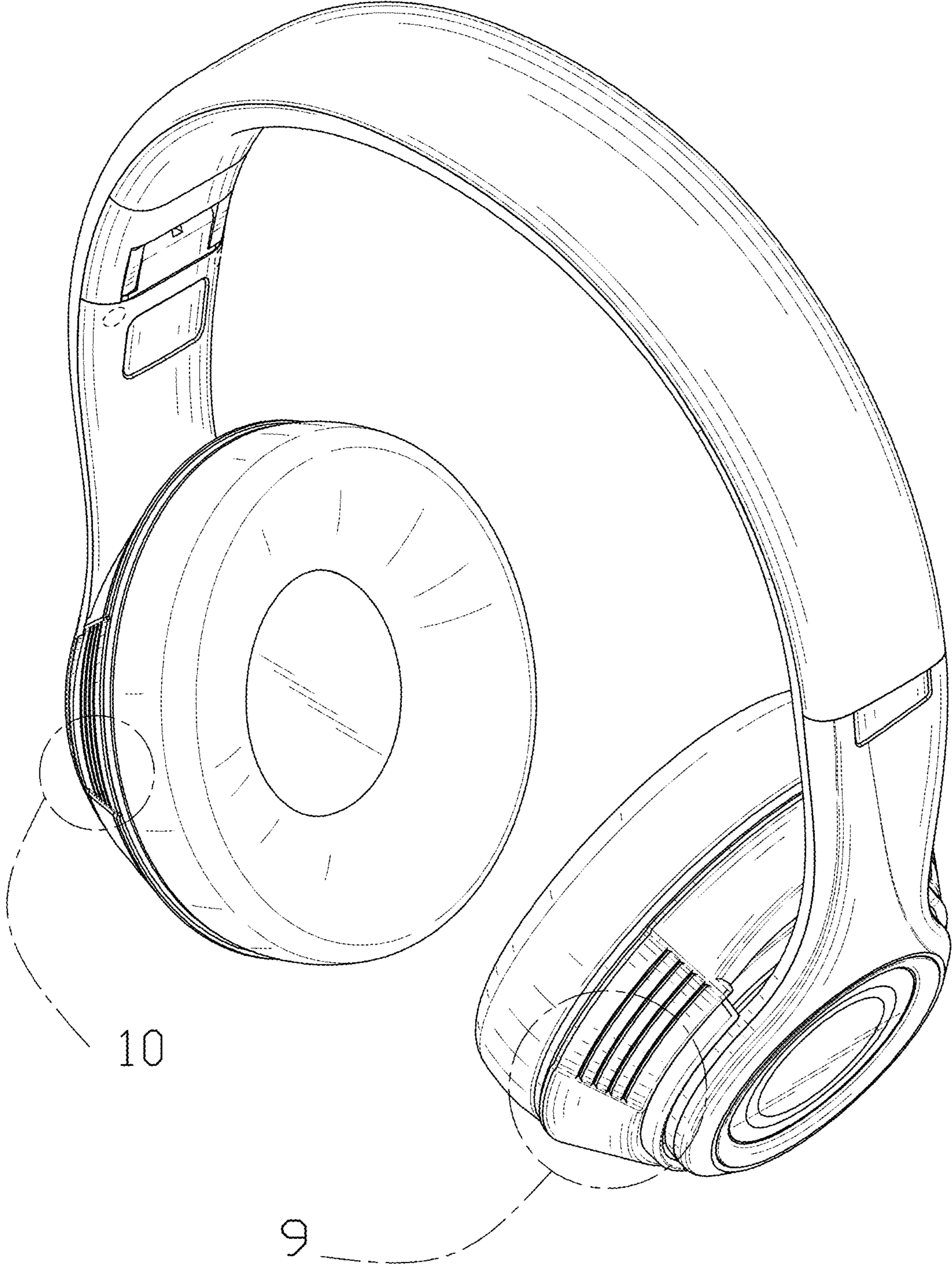


FIG. 1

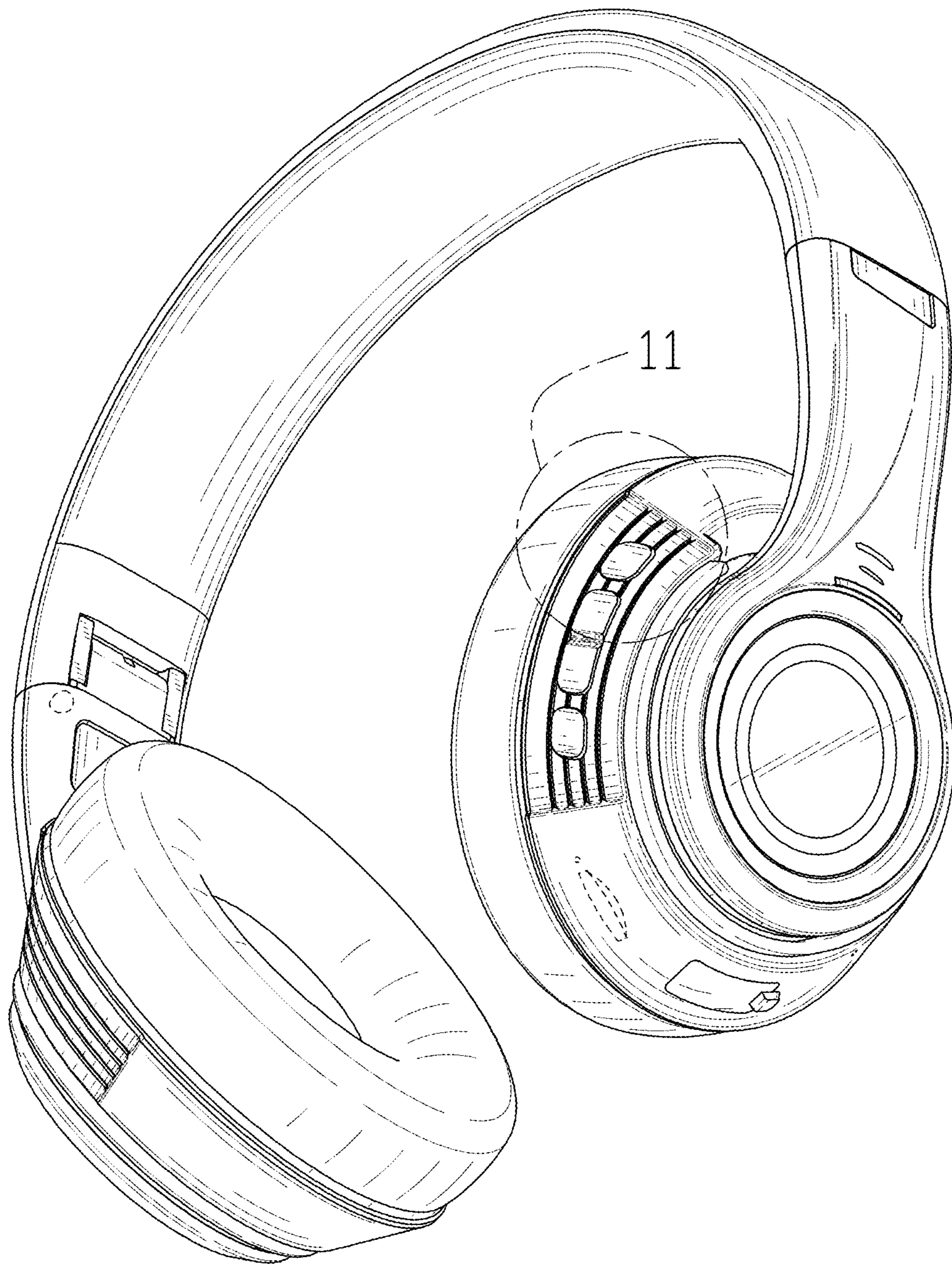


FIG. 2

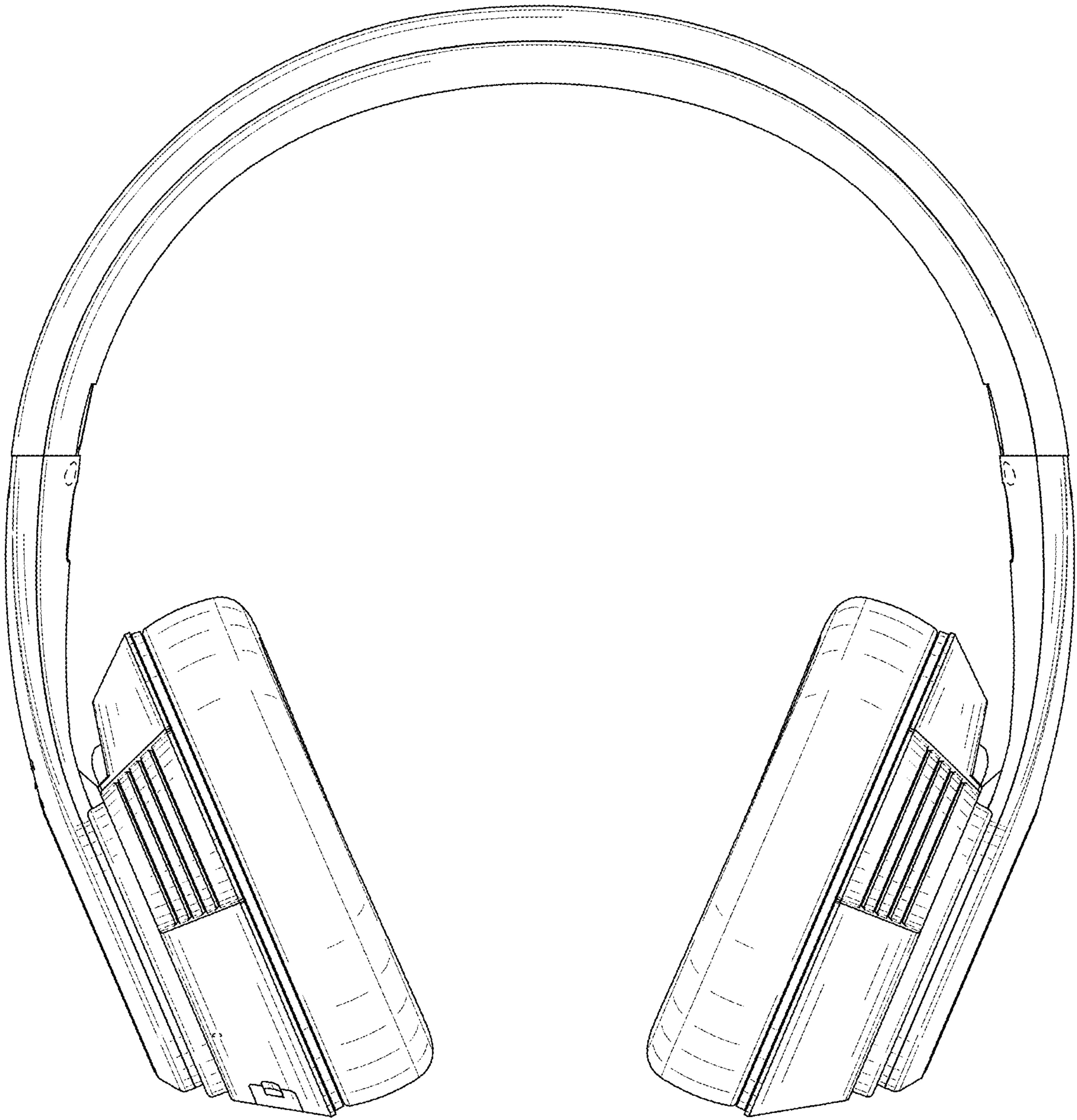


FIG. 3



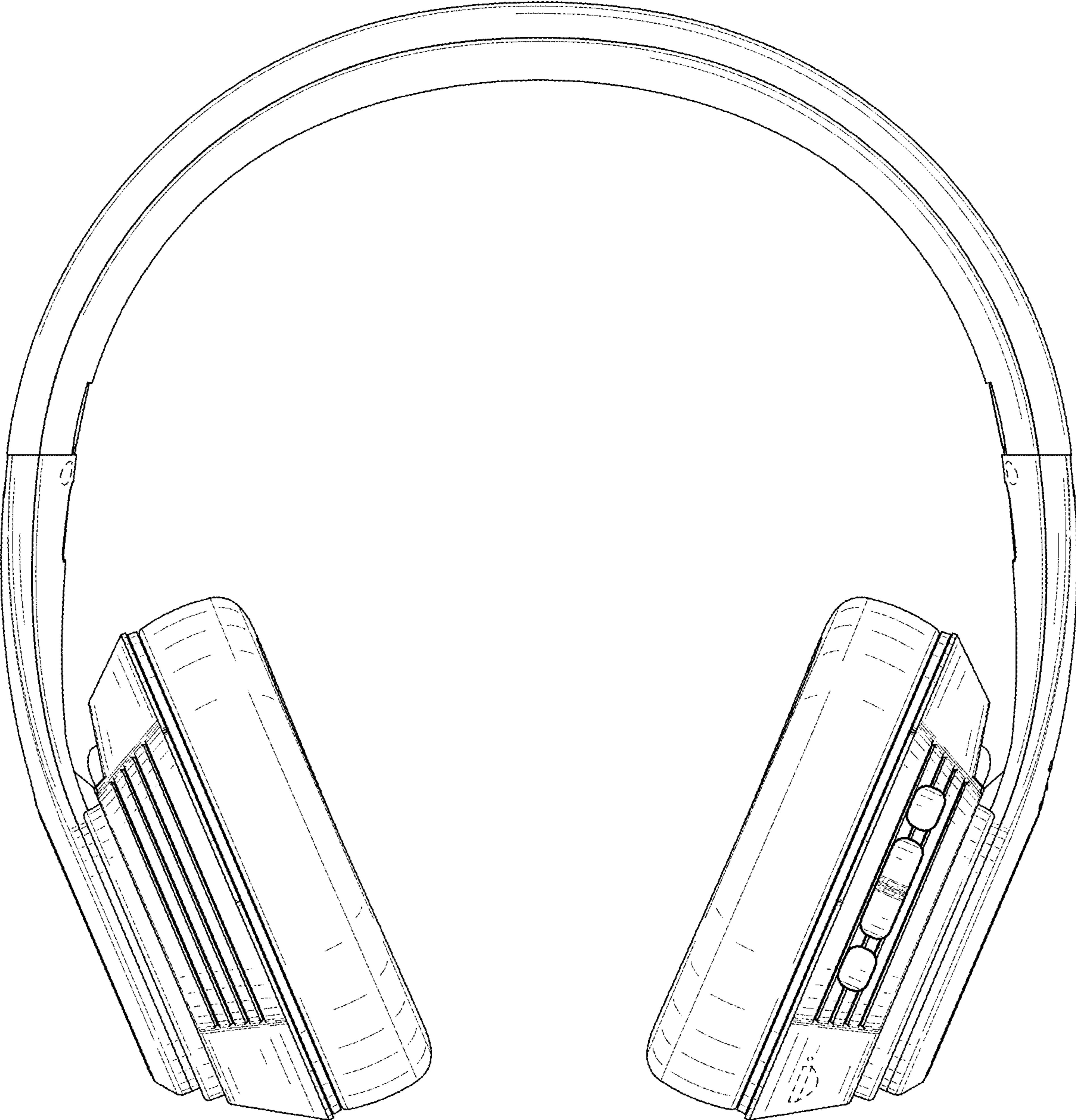


FIG. 4

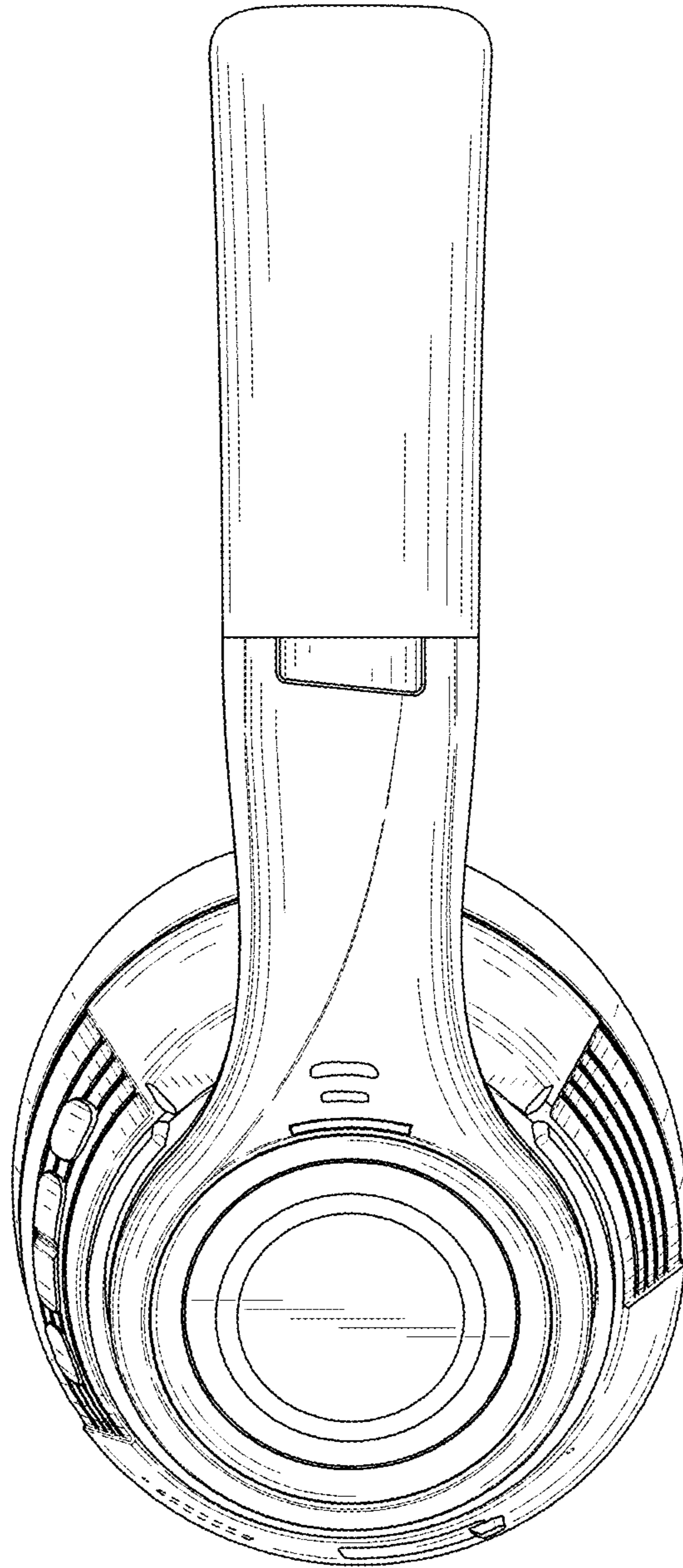


FIG. 5

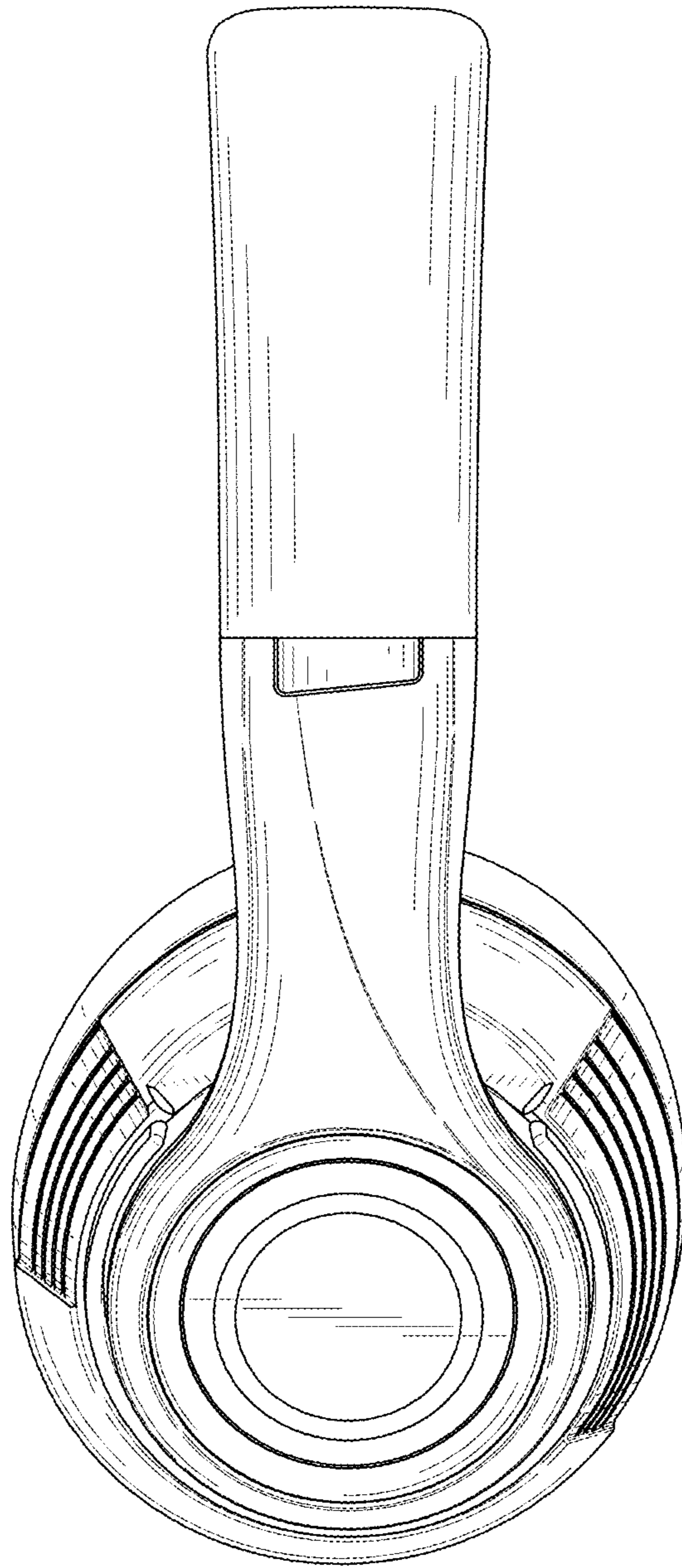


FIG. 6



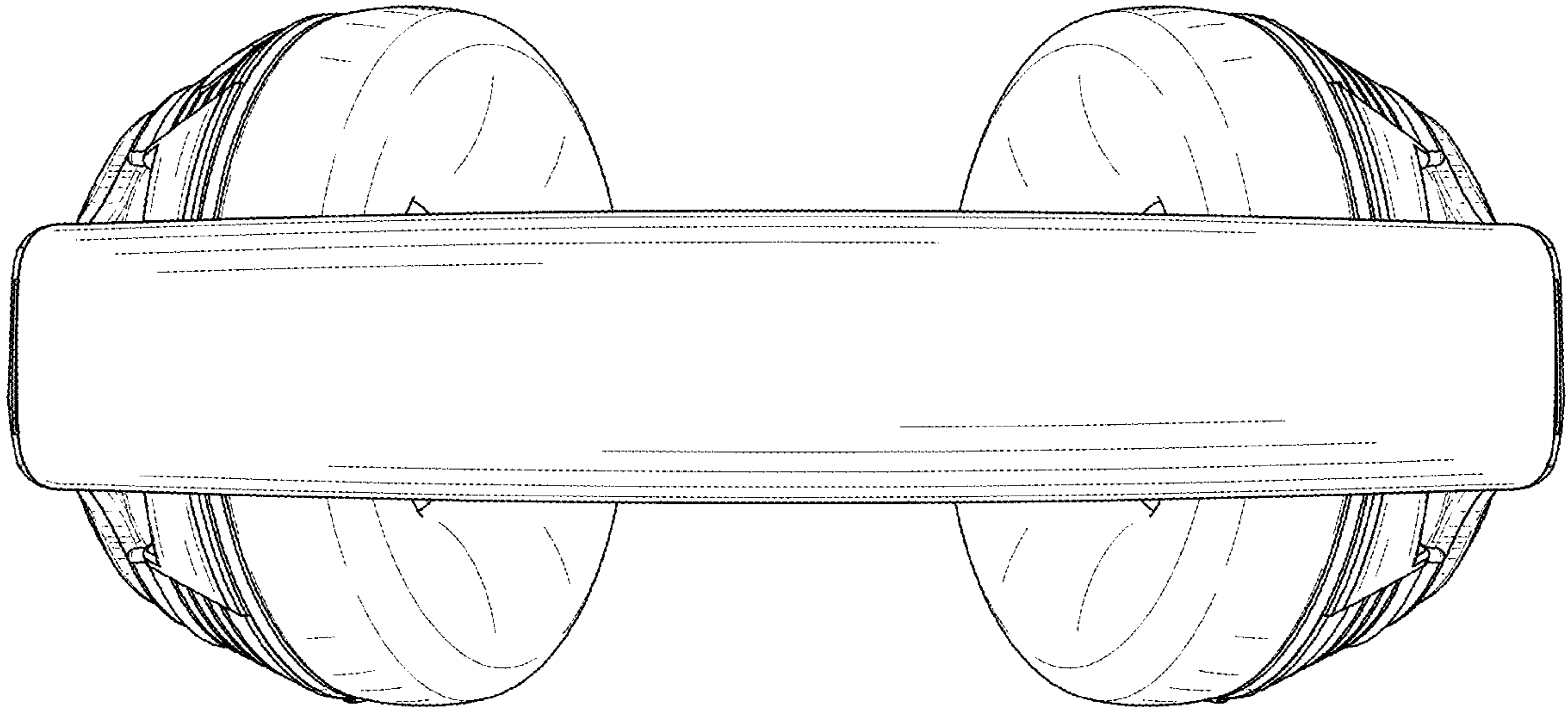


FIG. 7

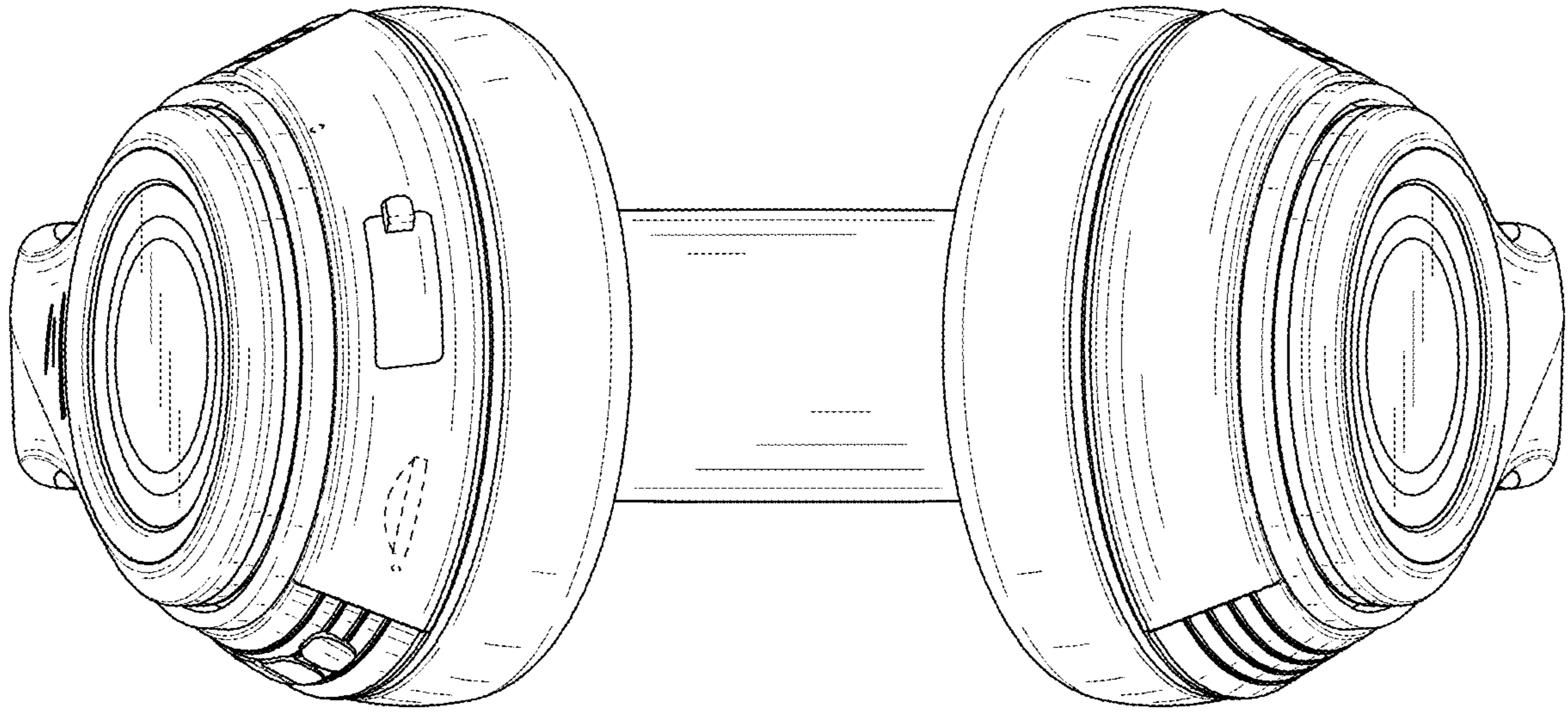


FIG. 8

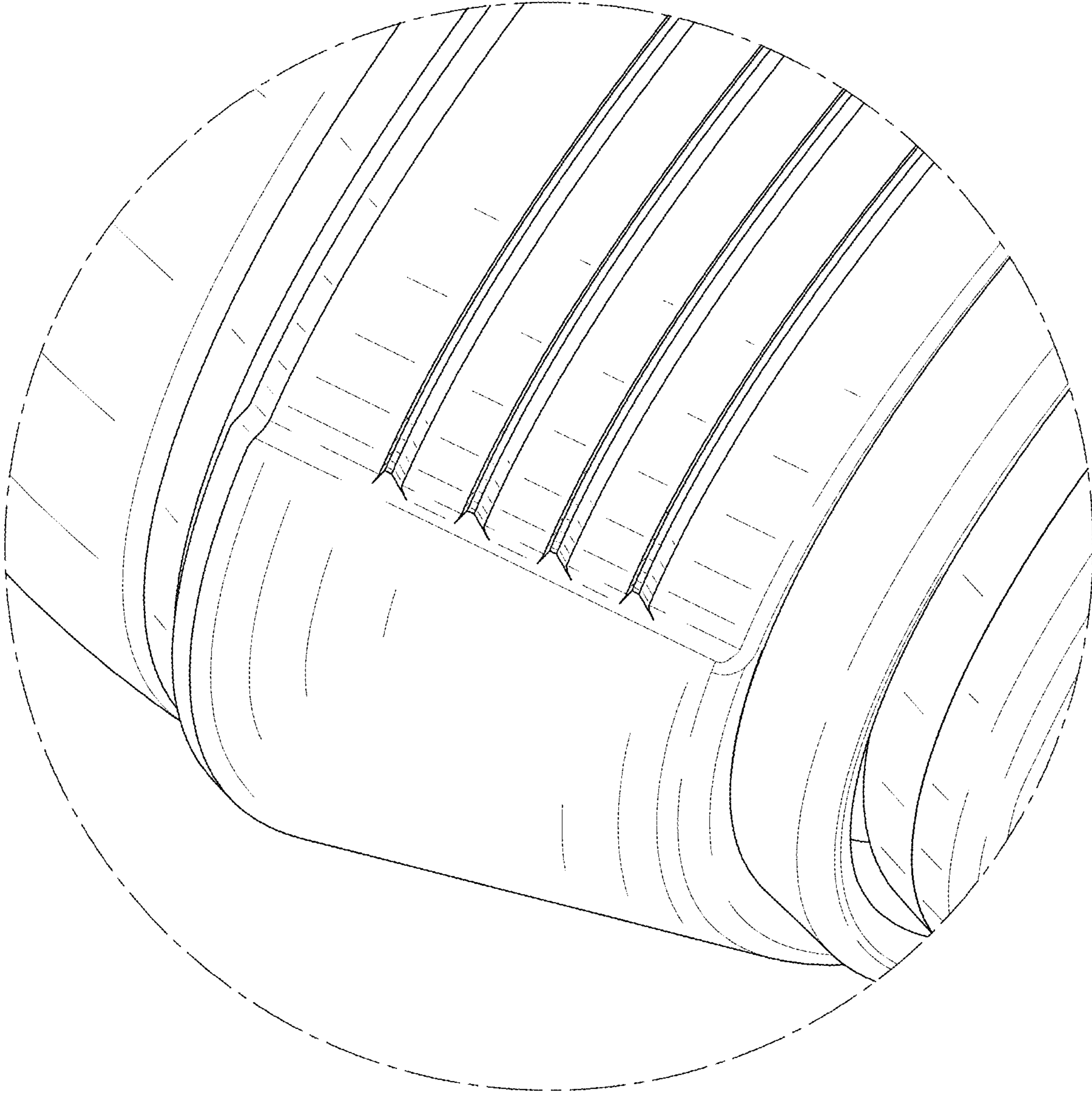


FIG. 9



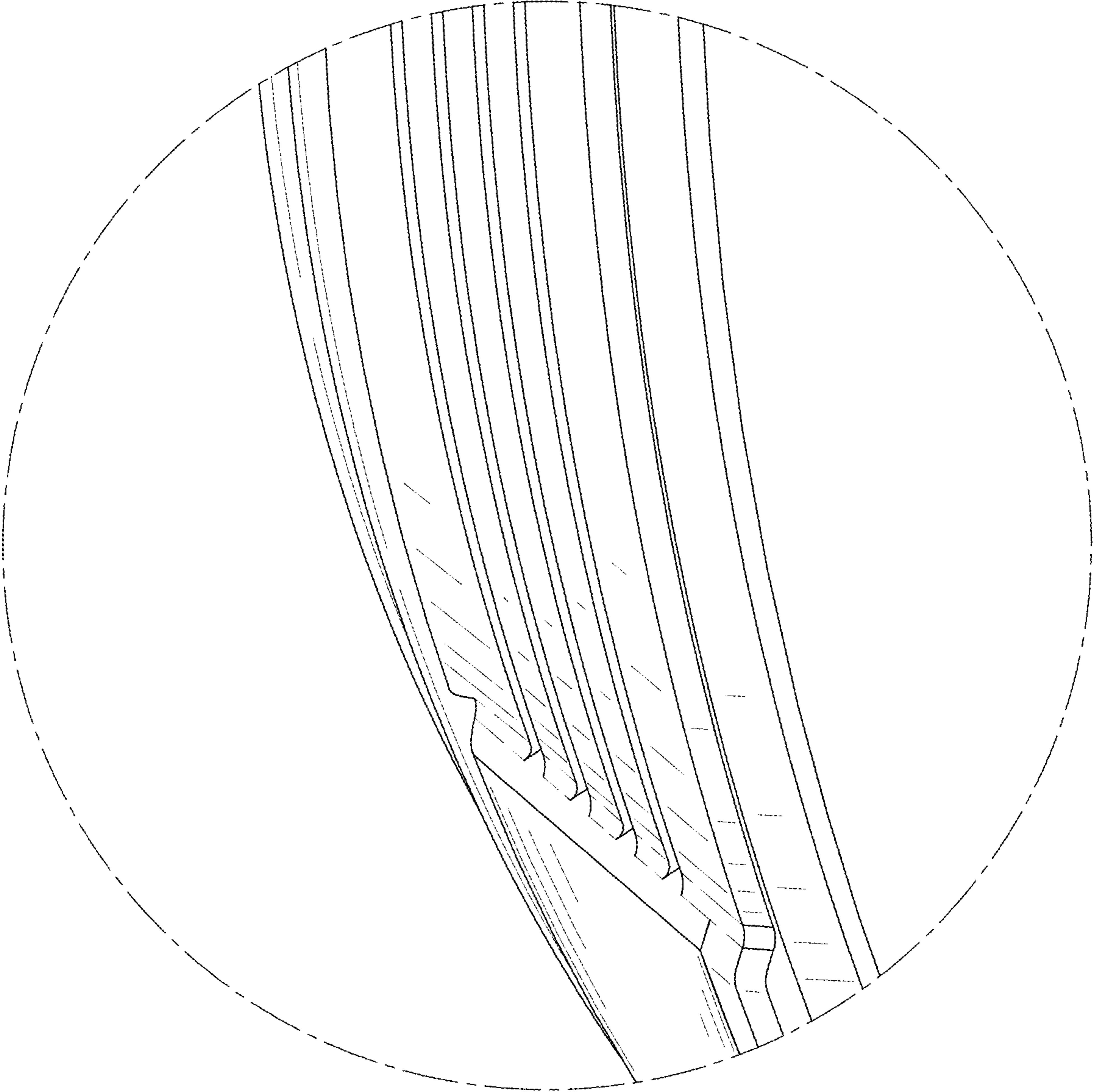


FIG. 10

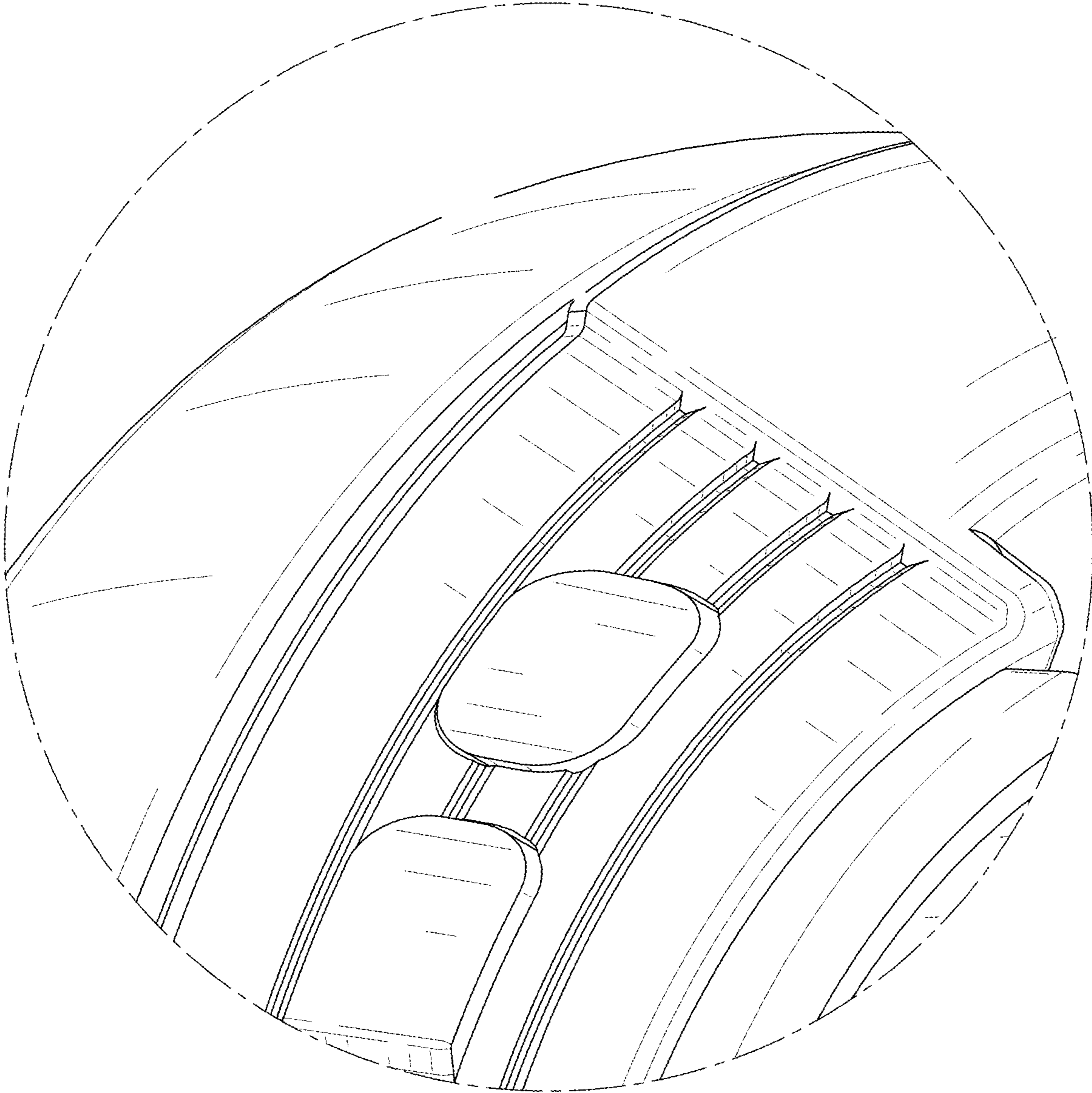


FIG. 11